



COMPLEMENTARY PAIR ENHANCEMENT MODE MOSFET

Product Summary

Device	BVDSS	R _{DS(ON)} max	I _D max T _A = +25°C
01		$25m\Omega$ @ V _{GS} = 4.5V	6.0A
Q1 N-Channel	12V	$30m\Omega$ @ V _{GS} = 3.3V	5.5A
14-Onamilei		$32m\Omega$ @ $V_{GS} = 2.5V$	5.3A
00		$80m\Omega @ V_{GS} = -4.5V$	-3.4A
Q2 P-Channel	-20V	90mΩ @ V _{GS} = -3.3V	-3.2A
1 Onamici		100mΩ @ V _{GS} = -2.5V	-3.0A

Features

- Low On-Resistance
- Low Input Capacitance
- Low Profile, 0.6mm Max Height
- ESD HBM Protected up to 1.5kV, MM Protected up to 150V
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative. https://www.diodes.com/quality/product-definitions/

Description

This MOSFET is designed to minimize the on-state resistance (RDS(ON)) and yet maintain superior switching performance, making it ideal for high-efficiency power management applications.

Applications

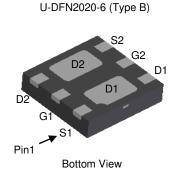
Optimized for Point of Load (POL) Synchronous Buck Converter that steps down from 3.3V to 1V for core voltage supply to ASICs. Target applications are Ethernet Network Controllers used in:

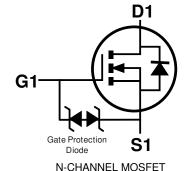
- Routers, Switchers, Network Interface Controllers (NICs)
- Digital Subscriber Line (DSL)
- Set-Top Boxes (STBs)

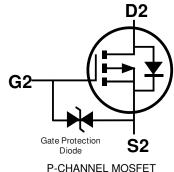
Mechanical Data

- Case: U-DFN2020-6
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish NiPdAu over Copper Leadframe. Solderable per MIL-STD-202, Method 208 (4)
- Terminals Connections: See Diagram Below
- Weight: 0.0065 grams (Approximate)









Internal Schematic

Ordering Information (Note 4)

Part Number	Case	Packaging
DMC1028UFDB-7	U-DFN2020-6 (Type B)	3,000/Tape & Reel
DMC1028UFDB-13	U-DFN2020-6 (Type B)	10,000/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.



Marking Information

Site 1



D8 = Product Type Marking Code YM = Date Code Marking Y = Year (ex: H = 2020) M = Month (ex: 9 = September)

Date Code Key

Year	2014		2020	2021	2022	2023	2024	2025	2026	2027	2028	2029
Code	В		Н		J	K	L	М	N	0	Р	R
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec

Site 2



D8 = Product Type Marking Code YWX = Date Code Marking Y = Year (ex: 0 = 2020)
W = Week (ex: a = Week 27; z Represents Week 52 and 53)
X = Internal Code (ex: U = Monday)

Date Code Key

Year	2014		2020	2021	2022	2023	2024	2025	2026	2027	2028	2029
Code	4		0	1	2	3	4	5	6	7	8	9
Week		1-	·26			27	-52			5	3	
Code		Α	-Z			а	-Z			7	Z	
Internal Code	Sui	n	Mon		Tue	W	ed	Thu		Fri		Sat
Code	Т		U		V	\	٧	Х		Υ		Z
	T		U		V	_		X		Y		Z



Maximum Ratings (@ $T_A = +25^{\circ}C$, unless otherwise specified.)

Characteristic	Symbol	Q1 N-CHANNEL	Q2 P-CHANNEL	Unit		
Drain-Source Voltage			V _{DSS}	12	-20	V
Gate-Source Voltage			Vgss	±8	±8	V
Continuous Drain Current (Note 5) N-Channel: V _{GS} = 4.5V	Steady State	$T_A = +25$ °C $T_A = +70$ °C	I _D	6.0 4.8	-3.4 -2.7	А
P-Channel: VGS = 4.5V	t < 5s	T _A = +25°C T _A = +70°C	ID	7.1 5.7	-4.0 -3.2	Α
Maximum Continuous Body Diode Forward Cur	rent (Note 5)	ls	1.4	-1.4	Α
Pulsed Drain Current (10µs Pulse, Duty Cycle =	I _{DM}	40	-20	Α		
Avalanche Current L = 0.1mH	las	12	-12	Α		
Avalanche Energy L = 0.1mH			Eas	8.4	7.5	mJ

Thermal Characteristics

Characteristic	Symbol	Value	Unit		
Total Power Dissipation (Note 5)	Steady State	Pn	1.36	W	
Total Fower Dissipation (Note 3)	t < 5s	רט	1.89	VV	
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	Davi	92		
Thermal Resistance, Junction to Ambient (Note 5)	t < 5s	Reja	66	°C/W	
Thermal Resistance, Junction to Case (Note 5)	Rejc	19			
Operating and Storage Temperature Range	T _{J,} T _{STG}	-55 to +150	°C		

Note: 5. Device mounted on 1" \times 1" FR-4 PCB with high coverage 2oz. Copper, single sided.

Electrical Characteristics Q1 N-CHANNEL (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition		
OFF CHARACTERISTICS (Note 6)								
Drain-Source Breakdown Voltage	BVDSS	12	I	_	٧	$V_{GS} = 0V, I_{D} = 250\mu A$		
Zero Gate Voltage Drain Current T _J = +25°C	IDSS	l	I	1.0	μΑ	$V_{DS} = 12V$, $V_{GS} = 0V$		
Gate-Source Leakage	Igss		l	±10	μΑ	$V_{GS} = \pm 8V$, $V_{DS} = 0V$		
ON CHARACTERISTICS (Note 6)								
Gate Threshold Voltage	Vgs(TH)	0.4	_	1	V	$V_{DS} = V_{GS}$, $I_D = 250\mu A$		
		_	17	25		$V_{GS} = 4.5V, I_{D} = 5.2A$		
Static Drain-Source On-Resistance	Process	_	19	30	mΩ	$V_{GS} = 3.3V, I_{D} = 5.0A$		
Static Dialii-Source Off-nesistance	RDS(ON)	1	21	32	11122	$V_{GS} = 2.5V, I_{D} = 4.8A$		
			30	40		$V_{GS} = 1.8V, I_D = 2.5A$		
Diode Forward Voltage	V _{SD}	_	0.7	1.2	V	V _G S = 0V, I _S = 1A		
DYNAMIC CHARACTERISTICS (Note 7)								
Input Capacitance	Ciss	l	787	_	pF	V 0V V 0V		
Output Capacitance	Coss	_	203	_	pF	V _{DS} = 6V, V _{GS} = 0V, f = 1.0MHz		
Reverse Transfer Capacitance	Crss		177	_	pF	1 = 1.01/1112		
Gate Resistance	Rg	_	4.8	_	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$		
Total Gate Charge (V _{GS} = 3.3V)		_	7.9	_	nC			
Total Gate Charge (VGS = 4.5V)	Qg	_	10.5	_	nC			
Total Gate Charge (VGS = 8V)		_	18.5	_	nC	$V_{DS} = 6V, I_{D} = 6.8A$		
Gate-Source Charge	Qgs	_	1.2	_	nC			
Gate-Drain Charge	Qgd	_	2.9	_	nC			
Turn-On Delay Time	t _{D(ON)}	_	4.6	_	ns			
Turn-On Rise Time	tr	_	9.4	_	ns	$V_{DD} = 6V, V_{GS} = 4.5V,$		
Turn-Off Delay Time	tD(OFF)	_	15.7	_	ns	$R_L = 1.1\Omega$, $R_G = 1\Omega$		
Turn-Off Fall Time	t _F	_	3.7	_	ns	1		
Body Diode Reverse Recovery Time	trr	_	12.0	_	ns	Is = 5.4A, dI/dt = 100A/µs		
Body Diode Reverse Recovery Charge	Q _{RR}	_	1.8	_	nC	$I_S = 5.4A$, $dI/dt = 100A/\mu s$		

6. Short duration pulse test used to minimize self-heating effect. 7. Guaranteed by design. Not subject to product testing. Notes:



Electrical Characteristics Q2 P-CHANNEL (@TA = +25°C, unless otherwise specified.)

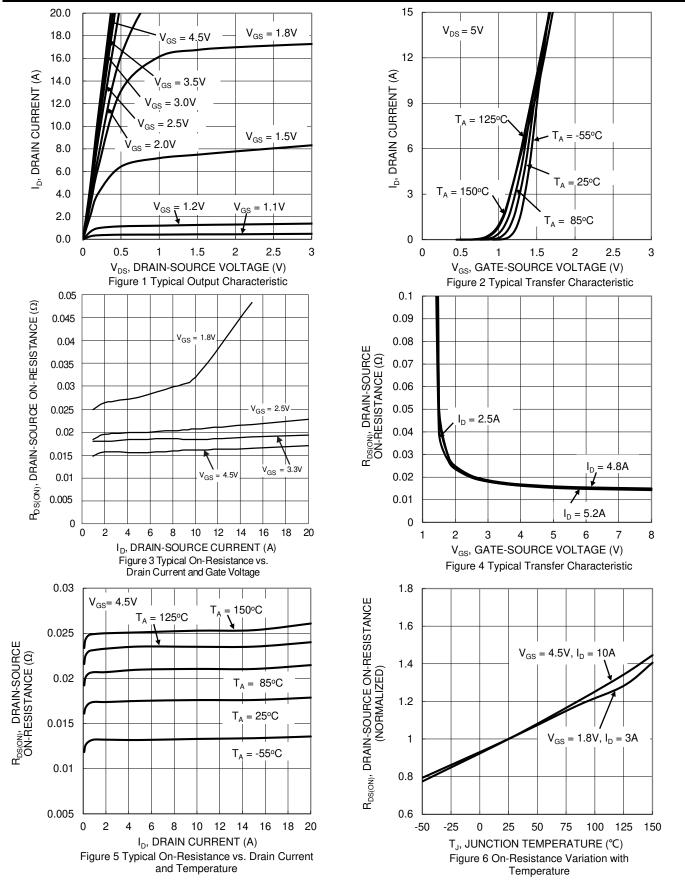
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition		
OFF CHARACTERISTICS (Note 6)	Oyso.		. , , ,	max	- Cilit	100t obnation		
Drain-Source Breakdown Voltage	BV _{DSS}	-20	_	_	V	$V_{GS} = 0V, I_D = -250\mu A$		
Zero Gate Voltage Drain Current T _J = +25°C	IDSS	_	_	-1.0	μA	V _{DS} = -20V, V _{GS} = 0V		
Gate-Source Leakage	Igss	_	_	±10	μA	$V_{GS} = \pm 8V$, $V_{DS} = 0V$		
ON CHARACTERISTICS (Note 6)								
Gate Threshold Voltage	V _{GS(TH)}	-0.4	_	-1	٧	$V_{DS} = V_{GS}$, $I_D = -250\mu A$		
			55	80		$V_{GS} = -4.5V$, $I_{D} = -3.8A$		
		l	63	90		$V_{GS} = -3.3V$, $I_{D} = -3.5A$		
Static Drain-Source On-Resistance	R _{DS(ON)}	_	70	100	mΩ	$V_{GS} = -2.5V$, $I_D = -3.3A$		
		_	88	140		$V_{GS} = -1.8V$, $I_{D} = -1.0A$		
		_	110	210		$V_{GS} = -1.5V$, $I_{D} = -0.5A$		
Diode Forward Voltage	V _{SD}	_	-0.7	-1.2	V	V _G S = 0V, I _S = -1A		
DYNAMIC CHARACTERISTICS (Note 7)								
Input Capacitance	Ciss	_	576	_	pF	101/11/		
Output Capacitance	Coss	_	87	_	pF	V _{DS} = -10V, V _{GS} = 0V, -f = 1.0MHz		
Reverse Transfer Capacitance	Crss		71		рF	1 - 1.0Wi iz		
Gate Resistance	Rg	_	15	_	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$		
Total Gate Charge (VGS = -3.3V)			5.2		nC			
Total Gate Charge (V _{GS} = -4.5V)	Q_g	_	6.7	_	nC			
Total Gate Charge (VGS = -8V)		_	11.5	_	nC	$V_{DS} = -10V, I_{D} = -4.9A$		
Gate-Source Charge	Qgs	_	1.0	_	nC			
Gate-Drain Charge	Qgd	_	2.0	_	nC			
Turn-On Delay Time	td(ON)	_	3.5	_	ns			
Turn-On Rise Time	tR	_	3.6	_	ns	$V_{DD} = -10V, V_{GS} = -4.5V,$		
Turn-Off Delay Time	tD(OFF)	_	20.8	_	ns	$R_L = 2.6\Omega$, $R_G = 1\Omega$		
Turn-Off Fall Time	t _F	_	12.7	_	ns			
Body Diode Reverse Recovery Time	trr		13.1		ns	Is = -3.9A, dI/dt = 100A/µs		
Body Diode Reverse Recovery Charge	Qrr	_	3.9	_	nC	Is = -3.9A, dI/dt = 100A/µs		

Notes:

^{6.} Short duration pulse test used to minimize self-heating effect. 7. Guaranteed by design. Not subject to product testing.



Typical Characteristics - N-CHANNEL





Typical Characteristics - N-CHANNEL (continued)

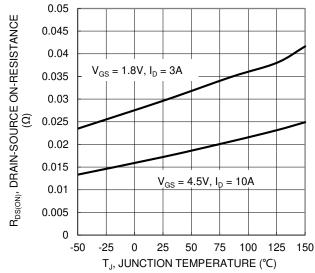


Figure 7 On-Resistance Variation with Temperature

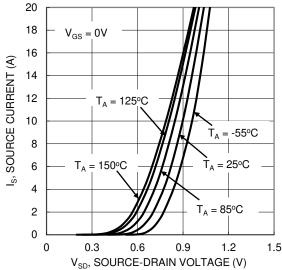
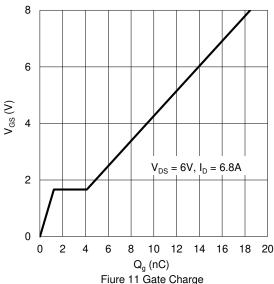
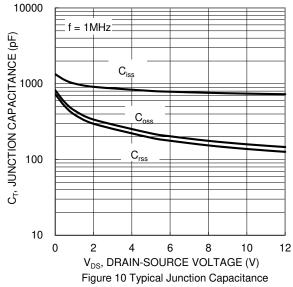


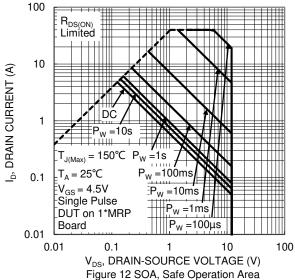
Figure 9 Diode Forward Voltage vs. Current



1.2 V_{GS(TH)}, GATE THRESHOLD VOLTAGE (V) 1.1 1 0.9 8.0 $I_D = 1mA$ 0.7 0.6 0.5 $I_{D} = 250 \mu A$ 0.4 0.3 0.2 0.1 0 25 50 75 100 125 T_J , JUNCTION TEMPERATURE (°C)

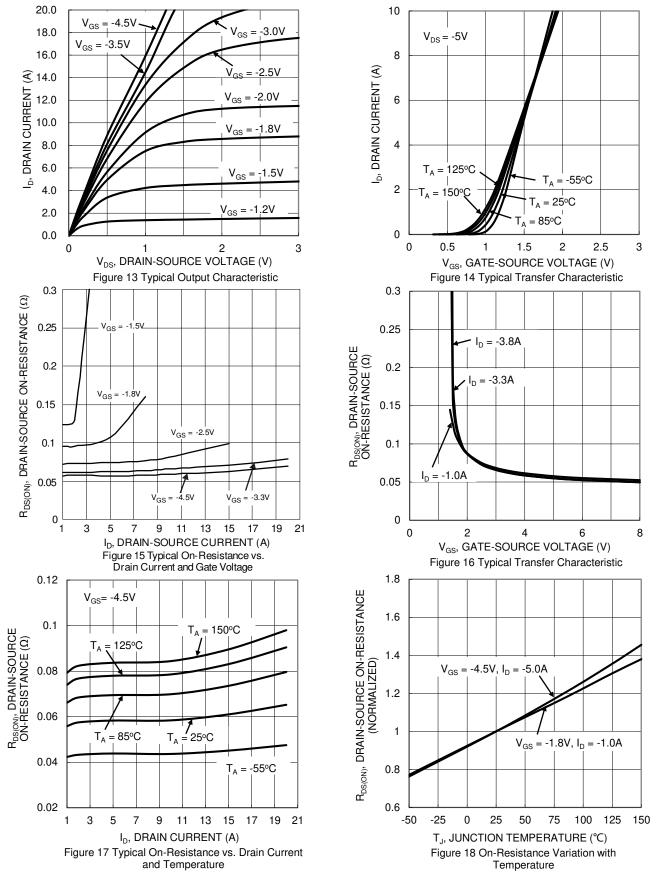
Figure 8 Gate Threshold Variation vs. Junction Temperature





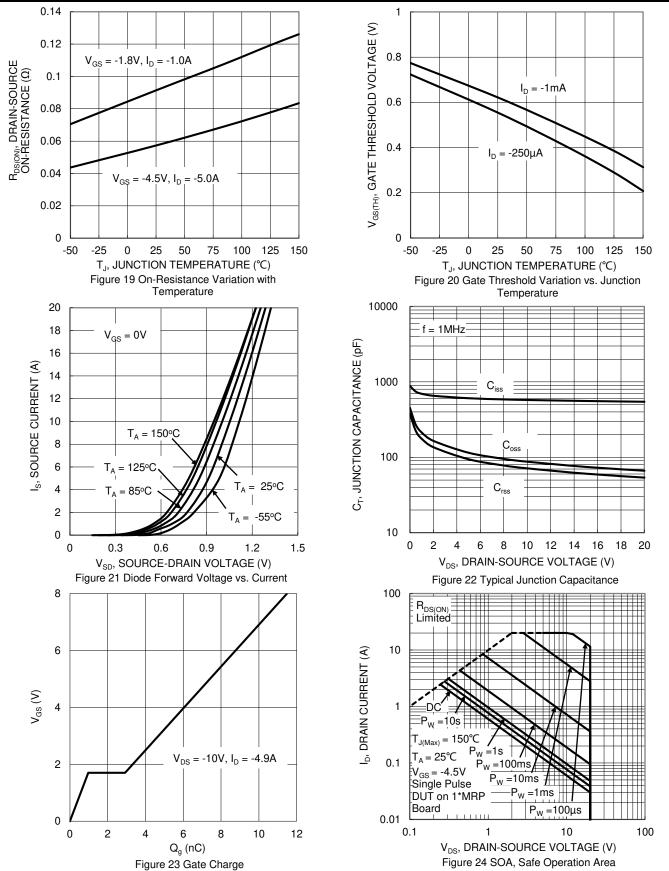


Typical Characteristics - P-CHANNEL





Typical Characteristics - P-CHANNEL (continued)





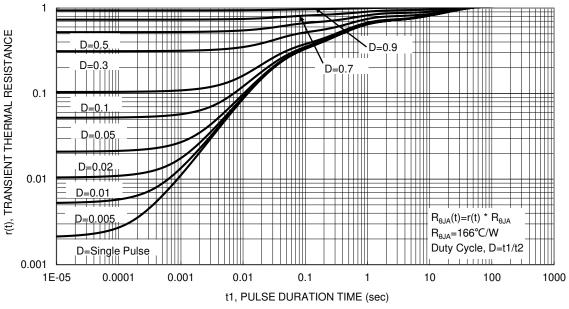
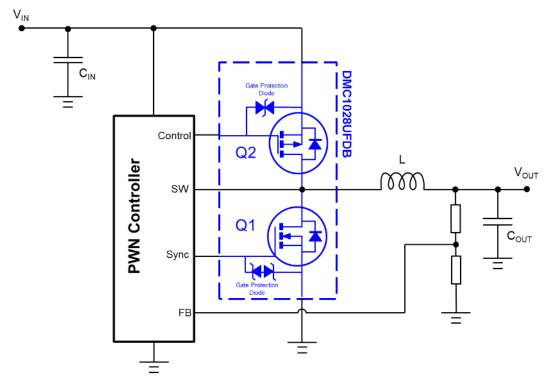


Figure 25 Transient Thermal Resistance

Typical Application Circuit



Example of a 3.3V to 1V POL Buck Converter using the DMC1028UFDB

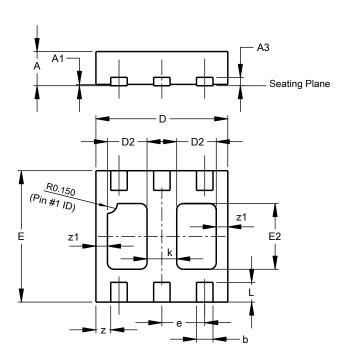
DMC1028UFDB is designed for Point-of-Load (POL) converter that is stepping down from a nominal 3.3V to 1V with a load current up to 3A. This is implemented with a separate ASIC that is PWM signaling the complementary MOSFETs to act as a synchronous buck converter. The control switch (Q2) is implemented with P-channel MOSFETs to avoid needing a charge pump and with the 3.3V to 1V step down, which has a duty cycle of 33%. This means that for 67% of the cycle, the synchronous switch (Q1) is on and efficiency is dominated by the conduction losses; hence, the need for low RDS(ON) N-channel MOSFETs. Whereas for the control switch (Q2), the gate charge needs to be minimized as the switching losses become significant.



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

U-DFN2020-6 (Type B)

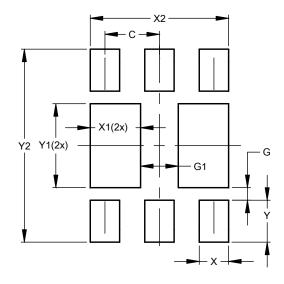


U-DFN2020-6								
Type B								
Dim	Min	Max	Тур					
Α	0.545	0.605	0.575					
A1	0.00	0.05	0.02					
A3	-	-	0.13					
b	0.20	0.30	0.25					
D	1.95	2.075	2.00					
D2	0.50	0.70	0.60					
е	1	-	0.65					
E	1.95	2.075	2.00					
E2	0.90	1.10	1.00					
k	-	-	0.45					
L	0.25	0.35	0.30					
Z	-	-	0.225					
z1	-	-	0.175					
All	Dimens	ions in	mm					

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

U-DFN2020-6 (Type B)



Dimensions	Value (in mm)
С	0.650
G	0.150
G1	0.450
Х	0.350
X1	0.600
X2	1.650
Υ	0.500
Y1	1.000
Y2	2.300



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